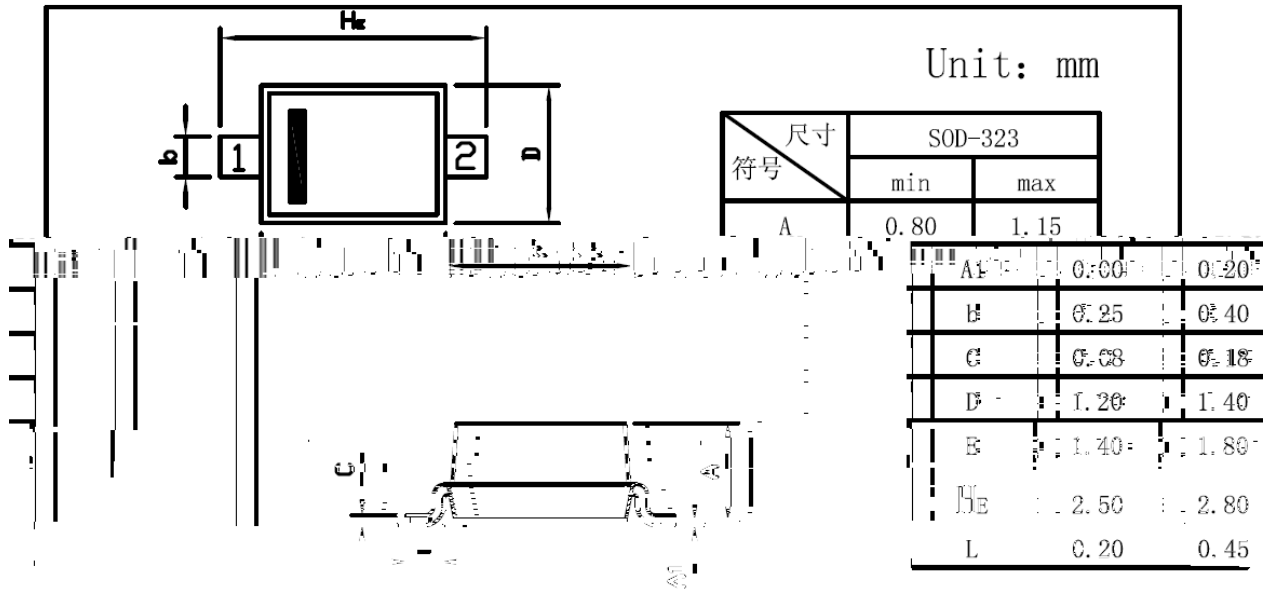




	θ		

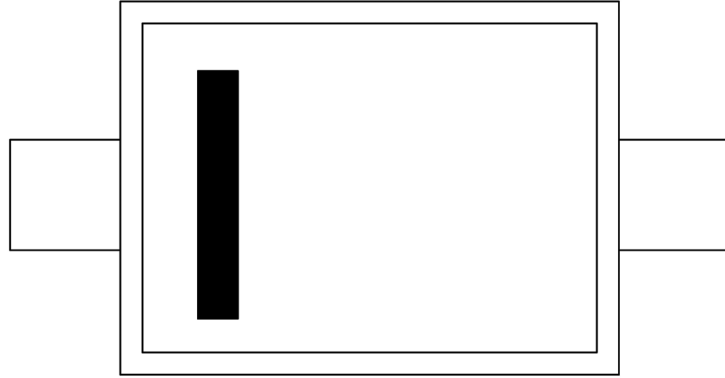


		μ		
				μ
		Ω		

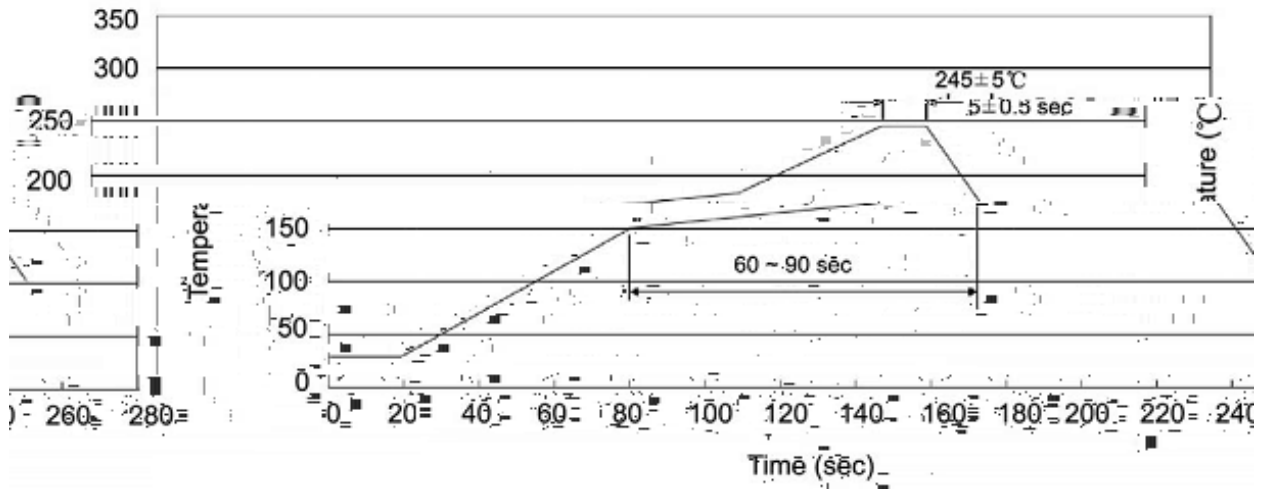


PIN: 1.CATHODE 2.ANODE

SOD-323



Temperature Profile for IR Reflow Soldering (Pb-Free)



± ± ± ±

± ± ± ±

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOD-323	3,000	10	30,000	6	180,000	7 × 8	180×120×180	390×385×205